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FOR IMMEDIATE RELEASE

Engineered Material Systems Introduces New UV Cured Adhesive for Bonding Lens Holders in Camera Modules

DELAWARE, OH — March 2017 — Engineered Material Systems, a leading global supplier of electronic materials for circuit assembly applications, is pleased to debut its 631-39 UV plus thermal cured adhesive for bonding lens holders in camera module applications.

The new material is designed to adhere to engineered plastics used in lens holder assemblies. These materials are engineered to withstand circuit board reliability test criteria.

The UV cured adhesive will cure rapidly when exposed to intense UV light centered at 365nm. After fixturing with UV, the adhesive can be cured in 15 minutes at 110°C. The 631-39 is the latest addition to Engineered Material Systems' extensive line of electronic materials for semiconductor, circuit assembly, photovoltaic, printer head, camera module, disk drive and photonic applications.



For more information about the 631-39 lens holder adhesive or to learn how Engineered Material Systems can define, develop and create an engineered material solution that is right for your company, visit www.emsadhesives.com.

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About Engineered Material Systems

Engineered Materials Systems, Inc. (EMS) technology focus is on electronic materials for semiconductor, circuit assembly, photovoltaic, printer head, camera module, disk drive and photonics assembly product lines. The company creates continual improvements that will guide its customers into the future. For more information, visit www.emsadhesives.com.